



PRODUCT DATASHEET



- Ceramic High Power
 3939 1.03t Series
- SWIR (1290~1350nm)





N0F52S57Z

APPLICATIONS:

- Industrial Curing
- Counterfeit Detection
- Medical Device
- Fluorochemistry
- Bacterial Identification
- Cosmetology
- Magnetic Particle Inspection
- Clean Room Inspection
- Mineralogy

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3939 1.03t Series



FEATURES:

- Package: Ceramic SMT Package with Glass Lens
- Forward Current: 60mA
- Forward Voltage (typ.): 1.3V
- Radiant Power (typ.): 180uW@60mA
- Colour: Infrared (IR)
- Wavelength: 1290-1350nm
- Viewing angle: 120°
- Materials:

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- Resin: Glass (Water Clear)
- L/F: Ceramic
- Operating Temperature: -40~+80°C
- Storage Temperature: -40~+80°C
- Grouping parameters:
 - Forward Voltage
 - Radiant Power
 - Peak Wavelength
- Soldering methods: IR Reflow soldering
- MSL: Level 3 according to J-STD020
- Packing: 12mm tape with min.100pcs/reel, ø180mm (7")
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CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

| Parameter | Symbol | Ratings | Unit |
|-----------------------|------------------|---------|------|
| Operating Temperature | Topr | -40~+80 | °C |
| Storage Temperature | T _{STG} | -40~+80 | °C |

Electrical & Optical Characteristics (Ta=25°C)

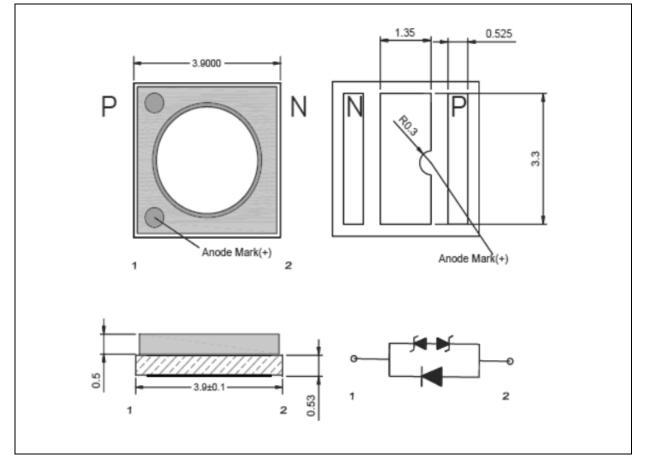
| Parameter | Symbol | Values | | | Unit | Test |
|-----------------|-------------------|--------|------|------|------|----------------------|
| | | Min. | Тур. | Max. | Unit | Condition |
| Forward Voltage | VF | 1.0 | 1.3 | 1.6 | V | I⊧=60mA |
| Radiant Power | Po | 170 | | | uW | I _F =60mA |
| Peak Wavelength | Wp | 1290 | 1300 | 1350 | nm | I⊧=60mA |
| Viewing Angle | 20 _{1/2} | | 120 | | deg | I _F =60mA |

1. Radiant Power (P_0) $\pm 10\%$, Forward Voltage (V_F) $\pm 0.05V$, Wavelength (nm) $\pm 2nm$



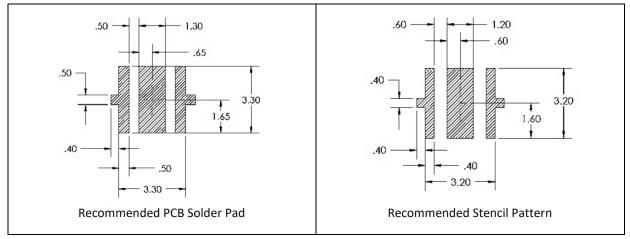
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- $\ \ 2. \quad \ \ Tolerance \ \ \pm 0.13 mm, \ unless \ \ otherwise \ noted.$

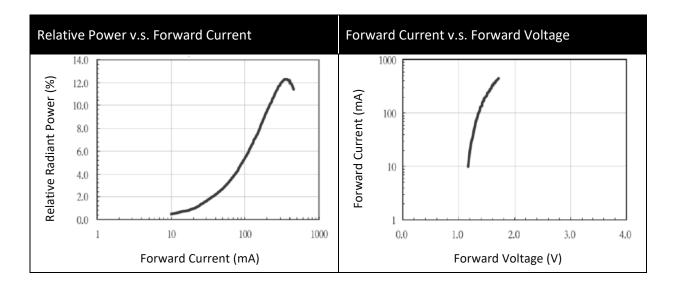


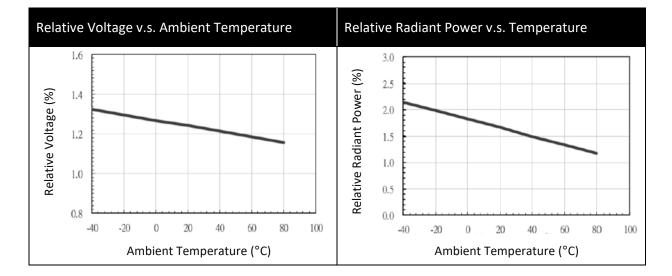


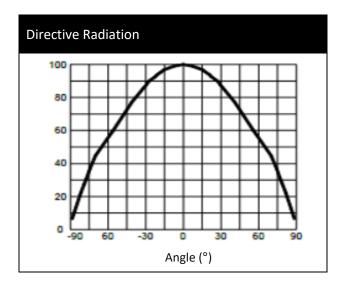
- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.12 mm with angle tolerance $\pm 0.5^{\circ}$.



ELECTRO-OPTICAL CHARACTERISTICS:



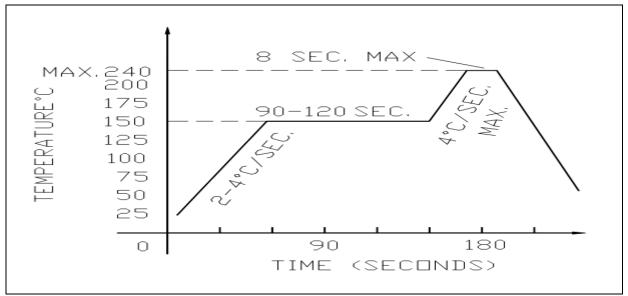






RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



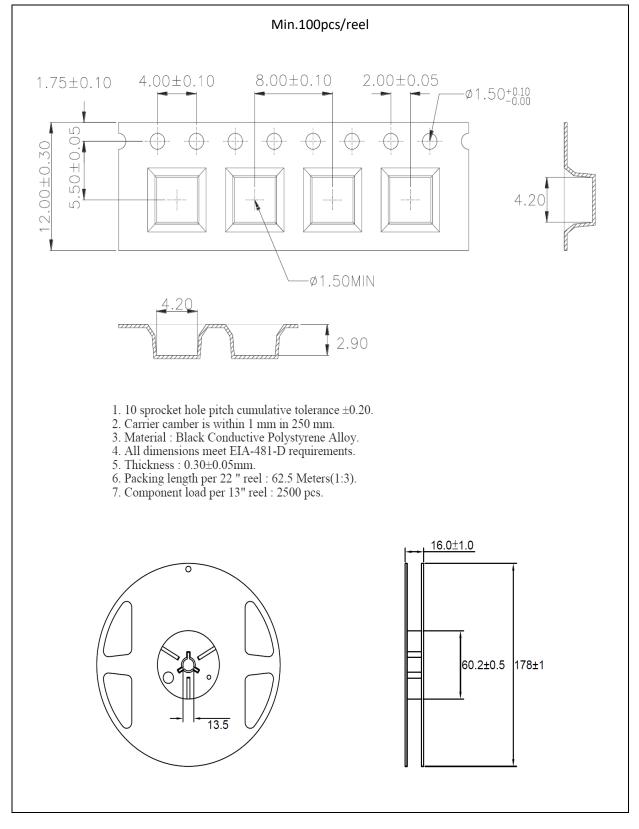
Note:

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- 1. Maximum reflow soldering: 2 times.
- 2. Recommended reflow temperature 240°C. Maximum soldering temperature should be limited to 245°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



Reel Dimension:



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PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

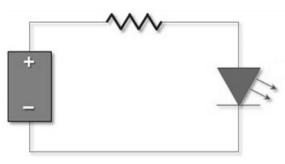
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 65±3°C x 12hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

| Version | Date | Summary of Revision |
|---------|------------|---------------------|
| A1.0 | 17/09/2020 | Datasheet set-up. |